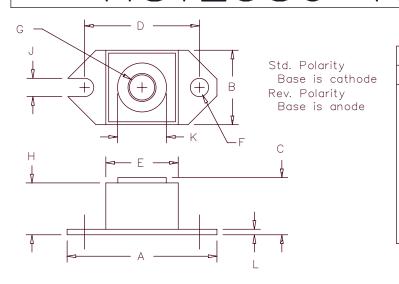
120 Amp Schottky Rectifier HS12380-HS123100



Dim	. Inches		Millimeter		
	Minimum	Maximum	Minimum	Maximum	Notes
A B C	1.52 .725 .605	1.56 .775 .625	38.61 18.42 15.37	39.62 19.69 15.88	
D E F	1.182 .745 .152	1.192 .755 .160	30.02 18.92 3.86	30.28 19.18 4.06	Sq. Dia.
G H J K	.525 .156 .495	1/4-20 .580 .160 .505	JNC-2B 13.34 3.96 12.57	14.73 4.06 12.83	Dia.
L	.120	.130	3.05	3.30	DIU.

Microsemi Catalog Number	Industry Part Number		Repetitive Peak Reverse Voltage
HS12380*	123NQ080 MBR12080	80V	80V
HS12390*		90V	90V
HS123100*	123NQ100 MBR120100	100V	100V
	*Add Suffix R fo	or Reverse Polarit	y

- Schottky Barrier Rectifier
- Guard Ring Protection
- 120 Amperes/80 to 100 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current
Maximum surge current
Maximum repetitive reverse current
Max peak forward voltage
Max peak forward voltage
Max peak reverse current
Max peak reverse current
Typical junction capacitance

| F(AV) 120 Amps | FSM 2000 Amps | R(OV) 2 Amps | VFM .76 Volts | VFM 0.91 Volts | RM 75 mA | RM 3.0 mA | C_J 3000 pF $^{T}C=112^{\circ}C,$ Square wave, $^{R}\theta JC=0.40^{\circ}C/W$ 8.3ms, half sine, $^{T}J=175^{\circ}C$ f = 1 KHZ, 25°C, 1µsec square wave $^{T}FM=120A:TJ=125^{\circ}C*$ $^{T}FM=120A:TJ=25^{\circ}C*$ $^{T}FM,^{T}J=125^{\circ}C*$ $^{T}VRM,^{T}J=125^{\circ}C$ $^{T}VRM,^{T}J=25^{\circ}C$ $^{T}VRM,^{T}J=25^{\circ}C$

*Pulse test: Pulse width 300µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range
Operating junction temp range
Max thermal resistance per leg
Typical thermal resistance (greased)
Terminal Torque
Mounting Base Torque
Weight

TSTG TJ ROJC ROCS

-55°C to 175°C -55°C to 175°C 0.40°C/W Junction to case 0.12°C/W Case to sink 35-40 inch pounds 20-25 inch pounds 1.1 ounces (32 grams) typical

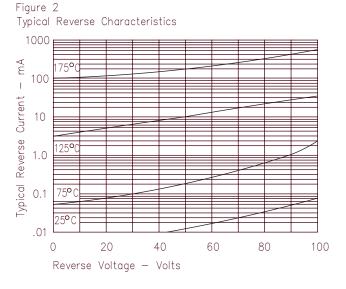


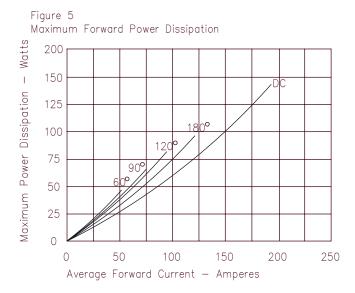
HS12380 - HS123100

Figure 1 Typical Forward Characteristics 1000 800 600 400 200 100 80 60 40 Amperes 20 I 10 Instantaneous Forward Current 8.0 6.0 4.0 2.0 1.0

Figure 3 Typical Junction Capacitance 6000 4000 2000 Junction Capacitance 1000 600 400 200 100 0.1 0.5 1.0 5.0 10 50 100 Reverse Voltage - Volts

Figure 4 Forward Current Derating 01 175 Maximum Allowable Case Temperature 165 155 145 135 125 115 180° 105 50 100 150 200 250 Average Forward Current - Amperes







0

0.2

0.4

Instantaneous Forward Voltage -

0.6

0.8

1.0

1.2

1.4

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